

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Tieyu Zheng	) I hereby certify that this paper and the documents referred to as enclosed
Serial No.: 10/706,209	therewith are being deposited with the United States Postal Service as first clas
Filed: November 12, 2003	<ul><li>mail, postage prepaid, on February 25,</li><li>2004, in an envelope addressed to</li></ul>
For: "Low-Profile Package for Housing an Optoelectronic Assembly"	Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.
Assignee: Intel Corporation	Marla L. Hudson Reg. No. 43,680
Group Art Unit: 2874	) Attorney for Applicant
Evaminer: To be Assigned	,

#### INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Pursuant to 37 C.F.R. § 1.56, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached Form PTO-1449. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits as far as is known to the undersigned.

Therefore, in accordance with 37 C.F.R. § 1.97(b), no certification or fee is required.

A copy of each reference listed on Form PTO-1449 is attached.

A concise explanation of relevance of the items listed on Form PTO-1449 is:

[X] not given

[] given for each listed item

[] given for only non-English language listed items

[] in the form of an English language copy of a Search Report from a foreign patent office, issued in a counterpart application, which refers to the relevant portions of the references

The Commissioner is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 13-2855, under Order No. 30320/15635X. A duplicate copy of this paper is enclosed.

Respectfully submitted,

MARSHALL, GERSTEIN & BORUN LLP 6300 Sears Tower

233 South Wacker Drive Chicago, Illinois 60606-6357

(312) 474-6300

February 25, 2004

By:

Marla L. Hudson

Reg. No. 43,680



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Group Art Unit: 2874	Attorney for Applicant
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L. Hudson

February 25, 2004

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U.S. Department of Commerce Patent and Trademark Office

Atty. Docket No.	Serial No.
30320/15635X	10/706,209
Applicant	
Tieyu Zheng	
Filing Date	Group
11/12/2003	2874

# INFORMATION DISCLOSURE STATEMENT

*Examiner	Patent Number	Issue Date	DOCUMENTS Name	Class	Subclass	Filing Date it
Initials	770 0000 (0000 000	10/01/0000				Appropriate
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	US-6515251	02-04-2003	Wind			
	US-6512861	01-28-2003	Chakravorty et al.			
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	US-Re.29325	07-26-1977	Hargis			<del> </del>

For PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Atty. Docket No. 30320/15635X	Serial No. 10/706,209		
INFORMATION DIS	CLOSURE STATEMENT	Applicant Tieyu Zheng			
in ordination bis	CEOSCIAE STATEMENT	Filing Date 11/12/2003	Group 2874		

FOREIGN PATENT DOCUMENTS							
*Examiner Initials		Document Number	Number Publication Date Country Class Subclass Translation		1		
						Yes	No
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	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)					
	Z.F. Shi et al., "Heat Sink Design Optimization for Optical Transponders," The 35th					
	International Symposium on Microelectronics, Denver, Colorado, September 4-6, 2002,					
	available at http://www.flotherm.com/technical_papers/t315.pdf					
	Kayner, "Tolerance considerations for 10 Gbit/s pluggable module EMI solutions and electrical					
	connector engagement," 8/01/02, available at http://www.xpak.org/XPAK%20whitepaper%20-					
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	News, pp. 21-23, 6/2000					

1	Examiner	Date Considered			
	*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in				
Į	conformance and not considered. Include copy of this form with next communication to applicant.				